

Features and Benefits

- □ Wide operating voltage range from 3.5V to 24V
- High sensitivity
- CMOS technology
- Chopper-stabilized amplifier stage
- Low current consumption
- Open drain output
- Inverted Output
- □ Thin SOT23 3L RoHS Compliant package

Application Examples

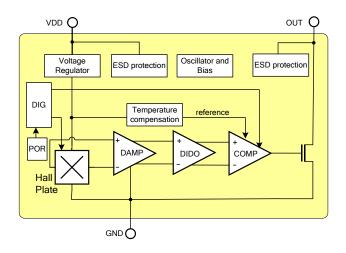
- □ Automotive, Consumer and Industrial
- Solid-state switch
- Interrupter
- Current detector
- Proximity detection

Ordering Information

Product Code	Temperature Code	Package Code	Option Code	Packing Form Code
US5682	E, K	SE	AAA-000	RE

Legend:	
Temperature Code:	E(-40°C to 85°C) K(-40°C to 125°C)
Package Code:	SE =TSOT-23L
Option Code:	AAA-000
Packing Form:	RE=Reel
Ordering example:	US5682ESE-AAA-000-RE
Ordening example.	U50002E5E-AAA-UUU-RE

1 Functional Diagram



2 General Description

The Melexis US5682 is a unipolar Hall-effect switch designed in mixed signal CMOS technology.

The device integrates a voltage regulator, Hall sensor with advanced Correlated Double Sampling (CDS) offset cancellation system and an open-drain output driver, all in a single package.

Thanks to its wide operating voltage range and temperature range, it is suitable for use in automotive and solid state switch applications.

The device is delivered in a Thin Small Outline Transistor (TSOT) 3-lead RoHS compliant package.



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3 Glossary of Terms

MilliTesla (mT), Gauss	Units of magnetic flux density:
	1mT = 10 Gauss
RoHS	Restriction of Hazardous Substances
TSOT	Thin Small Outline Transistor (TSOT package) – also referred with the Melexis package code "SE"
ESD	Electro-Static Discharge

4 Absolute Maximum Ratings

Parameter	Symbol	Value	Units
Supply Voltage	V _{DD}	28	V
Supply Current	ldd	50	mA
Output Voltage	V _{OUT}	28	V
Output Current	IOUT	50	mA
Operating Temperature Range	TA	-40 to 85	°C
Storage Temperature Range	Ts	-50 to 150	°C
Maximum Junction Temperature	TJ	165	°C

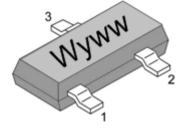
Table 1: Absolute maximum ratings

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

5 Pin Definitions and Descriptions

Pin №	Name	Туре	Function
1	VDD	Supply	Supply Voltage pin
2	OUT	Output	Open Drain Output pin
3	GND	Ground	Ground pin

Table 2: Pin definitions and descriptions





6 General Electrical Specifications

DC Operating Parameters $T_A = 25^{\circ}C$, $V_{DD} = 12V$ (unless otherwise	ise specified)
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Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Supply Voltage	V _{DD}	Operating	3.5		24	V
Supply Current	Idd	B < B _{RP}	0.5	2.5	5	mA
Output Saturation Voltage	V _{DSon}	I _{OUT} = 20mA, B < B _{RP}		0.3	0.5	V
Output Leakage Current	IOFF	B > B _{OP} , V _{OUT} = 24V		0.01	10	μA
Output Rise Time	tr	$R_L = 1k\Omega$, $C_L = 20pF$		0.25		μs
Output Fall Time	t _f	$R_L = 1k\Omega$, $C_L = 20pF$		0.25		μs
Maximum Switching Frequency	Fsw			5		KHz
Power-On Time ¹	ton				100	μs
Package Thermal Resistance	Rth	Single layer (1S) Jedec board		301		°C/W

 Table 3: Electrical specifications

¹ The Power-On Time represents the time from reaching the power-on reset level to the first refresh of the output (first valid output state).Value according simulation only, not subject to production test.

7 Magnetic Specifications

DC Operating Parameters $T_A = 25^{\circ}C$, $V_{DD} = 12V$ (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Operating Point	BOP		3.8	5.5	7.2	mT
Release Point	B _{RP}		2	3.5	5	mT
Hysteresis	Внуят		1.5	2	2.7	mT

Table 4: Magnetic specifications

DC Operating Parameters $T_A = -40^{\circ}$ C to 125° C (K-version), TA = -40° C to 85° C (E-version), VDD = 12V

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Operating Point	BOP		3.4		7.7	тт
Release Point	BRP		1.8		5.4	тт
Hysteresis	BHYST		1		2.8	mT

Table 5: Magnetic specifications



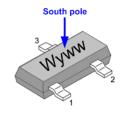
8 Output Behaviour versus Magnetic Pole

DC Operating Parameters $T_A = -40^{\circ}$ C to 125° C, $V_{DD} = 3.5$ V to 24V (unless otherwise specified)

Parameter	Test Conditions	OUT
South pole	B > B _{OP}	High
Null or weak magnetic field	$B \rightarrow 0 \text{ or } B < B_{RP}$	Low
North pole	B > B _{OP}	Low

Table 6: Output behaviour versus magnetic pole

9 Detailed General Description



OUT = High (≈V_{PU})

Based on mixed signal CMOS technology, Melexis US5682 is a Hall-effect device with high magnetic sensitivity and inverted output. Its sensitivity enables high accuracy in position sensing by the use of small air gap.

The Correlated Double Sampling (CDS) technique suppresses the offset generally observed with Hall sensors and amplifiers. The CMOS technology makes this advanced technique possible and contributes to smaller chip size and lower current consumption than bipolar technology. The small chip size is also an important factor to minimize the effect of physical stress.

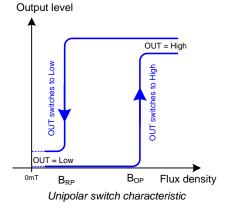
This combination results in more accurate and stable magnetic characteristics, and enables faster and more precise design.

The wide operating voltage from 3.5V to 24V and low current consumption make this device especially suitable for solid state switch applications.

The output signal is open-drain type. Such output allows simple connectivity with TTL or CMOS logic by using a pull-up resistor tied between a pull-up voltage and the device output.

10 Unique Features

The US5682 exhibits unipolar magnetic switching characteristics. Therefore, it operates only with one magnetic pole.



The US5682 device is inverted output, south pole active: Applying a south magnetic pole greater than B_{OP} facing the branded side of the package switches the output high.

Removing the magnetic field $(B\rightarrow 0)$ switches the output low. The use of the opposite magnetic pole facing the branded side does not affect the output state.

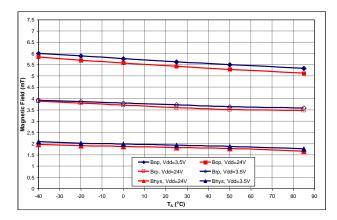
A magnetic hysteresis B_{HYST} keeps B_{OP} and B_{RP} separated by a minimal value. This hysteresis prevents output oscillation near the switching point.



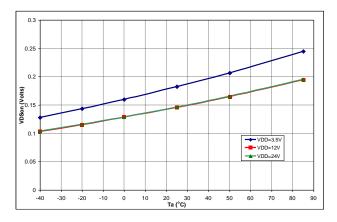
US5682 Unipolar Hall Switch – High Sensitivity Inverted Output

11 Performance Graphs

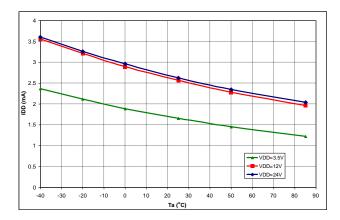
11.1 Magnetic parameters vs. T_A



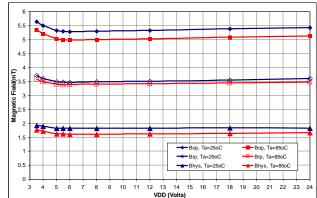
11.3 V_{DSon} vs. T_A



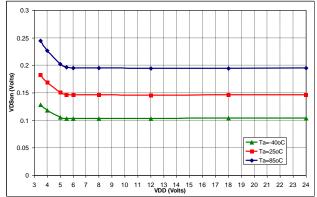
11.5 I_{DD} vs. T_A



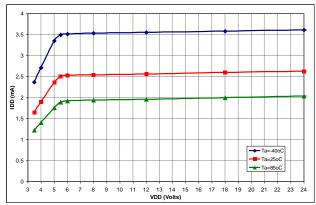
11.2 Magnetic parameters vs. V_{DD}



11.4 V_{DSon} vs. V_{DD}

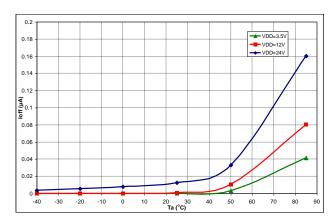


11.6 I_{DD} vs. V_{DD}

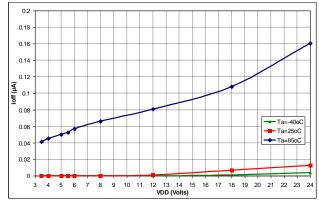




11.7 I_{OFF} vs. T_A



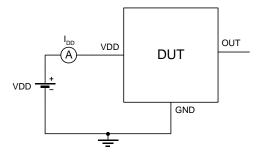
11.8 I_{OFF} vs. V_{DD}



12 Test Conditions

Note : DUT = Device Under Test

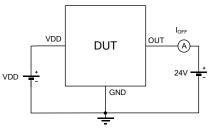
12.1 Supply Current



Note 1 - The supply current I_{DD} represents the static supply current. OUT is left open during measurement.

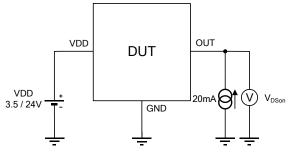
Note 2 - The device is put under magnetic field with $B < B_{RP}$.

12.3 Output Leakage Current



Note 1 - The device is put under magnetic field with $\mathsf{B}{>}\mathsf{B}_{\mathsf{OP}}$

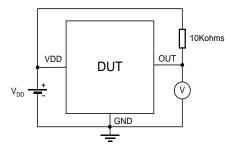
12.2 Output Saturation Voltage



Note 1 - The output saturation voltage V_{DSon} is measured at V_{DD} = 3.5V and V_{DD} = 24V.

Note 2 - The device is put under magnetic field with $\mathsf{B}{<}\mathsf{B}_{\mathsf{RP}}$

12.4 Magnetic Thresholds

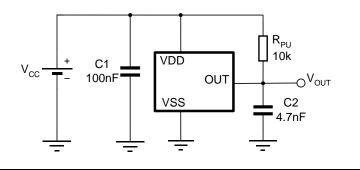


- Note 1 $B_{\rm OP}$ is determined by putting the device under magnetic field swept from $B_{\rm RPmin}$ up to $B_{\rm OPmax}$ until the output is switched on.
- Note 2 B_{RP} is determined by putting the device under magnetic field swept from B_{OPmax} down to B_{RPmin} until the output is switched off.

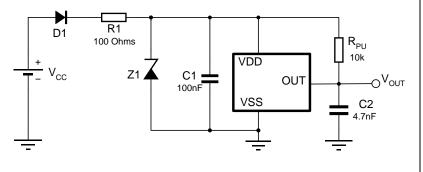


13 Application Information

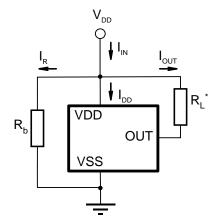
13.1 Typical Three-Wire Application Circuit







13.2 Two-Wire Circuit



Note:

With this circuit, precise ON and OFF currents can be detected using only two connecting wires.

The resistors RL and Rb can be used to bias the input current. Refer to the part specifications for limiting values.

 $\begin{array}{ll} B_{RP}: & I_{OFF} = I_R \ + \ I_{DD} = V_{DD}/R_b + I_{DD} \\ B_{OP}: & I_{ON} = I_{OFF} + I_{OUT} = I_{OFF} + V_{DD}/R_L \end{array}$

14 Application Comments

For proper operation, a 100nF bypass capacitor should be placed as close as possible to the device between the V_{DD} and ground pin.

For reverse voltage protection, it is recommended to connect a resistor or a diode in series with the V_{DD} pin. When using a resistor, three points are important:

- the resistor has to limit the reverse current to 50mA maximum (V_{CC} / R1 \leq 50mA)
- the resulting device supply voltage V_{DD} has to be higher than V_{DD} min ($V_{DD} = V_{CC} R1.I_{DD}$)
- the resistor has to withstand the power dissipated in reverse voltage condition ($P_D = V_{CC}^2 / R1$)
- When using a diode, a reverse current cannot flow and the voltage drop is almost constant (≈0.7V).

Therefore, a $100\Omega/0.25W$ resistor for 5V application and a diode for higher supply voltage are recommended. Both solutions provide the required reverse voltage protection.

When a weak power supply is used or when the device is intended to be used in noisy environment, it is recommended that figure 13.3 from the Application Information section is used.

The low-pass filter formed by R1 and C1 and the zener diode Z1 bypass the disturbances or voltage spikes occurring on the device supply voltage V_{DD} . The diode D1 provides additional reverse voltage protection.



15 Standard information regarding manufacturability of Melexis products with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to following test methods:

Reflow Soldering SMD's (Surface Mount Devices)

- IPC/JEDEC J-STD-020 Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)
- EIA/JEDEC JESD22-A113
 Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing
 (reflow profiles according to table 2)

Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EN60749-20
- Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat
 EIA/JEDEC JESD22-B106 and EN60749-15
- Resistance to soldering temperature for through-hole mounted devices

Iron Soldering THD's (<u>Through Hole Devices</u>)

• EN60749-15 Resistance to soldering temperature for through-hole mounted devices

Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

• EIA/JEDEC JESD22-B102 and EN60749-21 Solderability

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualifications of **RoHS** compliant products (RoHS = European directive on the Restriction Of the use of certain Hazardous Substances) please visit the quality page on our website: <u>http://www.melexis.com/quality.asp</u>

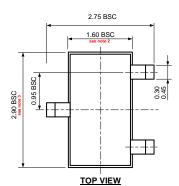
16 ESD Precautions

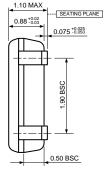
Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). Always observe Electro Static Discharge control procedures whenever handling semiconductor products.



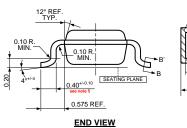
US5682 Unipolar Hall Switch – High Sensitivity Inverted Output

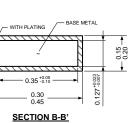
17 SE Package Information (TSOT-3L)





SIDE VIEW





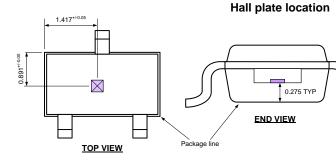
Notes:

1. All dimensions are in millimeters

- Outermost plastic extreme width does not include mold flash or protrusions. Mold flash and protrusions shall not exceed 0.15mm per side.
- Outermost plastic extreme length does not include mold flash or protrusions. Mold flash and protrusions shall not exceed 0.25mm per side.
- 4. The lead width dimension does not include dambar protrusion. Allowable dambar protrusion shall be 0.07mm total in excess of the lead width dimension at maximum material condition.
- 5. Dimension is the length of terminal for soldering to a substrate.
- 6. Dimension on SECTION B-B' applies to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
- Formed lead shall be planar with respect to one another with 0.076mm at seating plane.

Marking:

Top side : Wyww W = part number (US5682) y = last digit of year ww = calendar week



Notes: 1. All dimensions are in millimeters



US5682 Unipolar Hall Switch – High Sensitivity Inverted Output

18 Disclaimer

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